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TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC238F,TC74VHC238FN,TC74VHC238FT,TC74VHC238FK

3-to-8 Line Decoder

The TC74VHC238 is an advanced high speed CMOS 3-to-8 DECODER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

When the device is enabled, 3 Binary Select inputs (A, B and C) determine which one of the outputs (Y0-Y7) will go High.

When enable input G1 is held low or either $\overline{G}2A$ or $\overline{G}2B$ is held high, decoding function is inhibited and all outputs go Low.

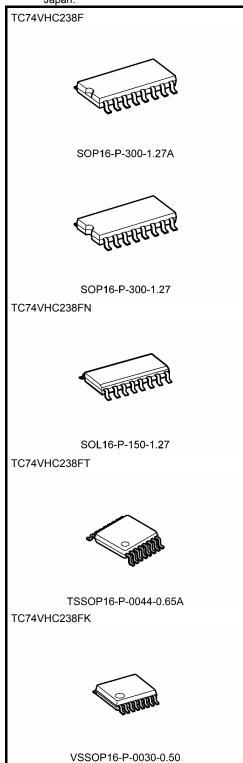
G1 G2A, and G2B inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High speed: $t_{pd} = 5.5 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25^{\circ}C$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Pin and function compatible with 74ALS238

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

 SOP16-P-300-1.27A
 : 0.18 g (typ.)

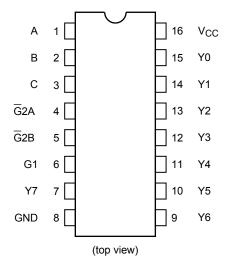
 SOP16-P-300-1.27
 : 0.18 g (typ.)

 SOL16-P-150-1.27
 : 0.13 g (typ.)

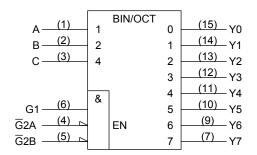
 TSSOP16-P-0044-0.65A
 : 0.06 g (typ.)

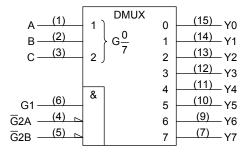
 VSSOP16-P-0030-0.50
 : 0.02 g (typ.)

Pin Assignment



IEC Logic Symbol



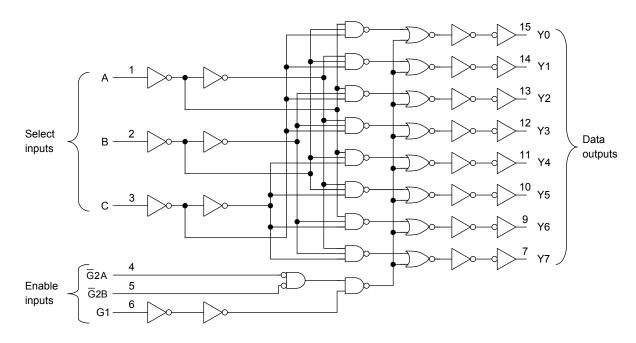


Truth Table

Inputs						Outputs									
Enable			Select			Y0	\/ 4	V2	\/2	V4	Y5	Y6	Y7	Selected Output	
G1	G ₂ A	G ₂ B	С	В	Α	10	Y1	Y2	Y3	Y4	15	10	17		
L	Х	Х	Χ	Х	Х	L	L	L	L	L	L	L	L	None	
Х	Н	Х	Х	Х	Х	L	L	L	L	L	L	L	L	None	
Х	Х	Н	Х	Х	Х	L	L	L	L	L	L	L	L	None	
Н	L	L	L	L	L	Н	L	L	L	L	L	L	L	Y0	
Н	L	L	L	L	Н	L	Н	L	L	L	L	L	L	Y1	
Н	L	L	L	Н	L	L	L	Н	L	L	L	L	L	Y2	
Н	L	L	L	Н	Н	L	L	L	Н	L	L	L	L	Y3	
Н	L	L	Н	L	L	L	L	L	L	Н	L	L	L	Y4	
Н	L	L	Н	L	Н	L	L	L	L	L	Н	L	L	Y5	
Н	L	L	Н	Н	L	L	L	L	L	L	L	Н	L	Y6	
Н	L	L	Н	Н	Н	L	L	L	L	L	L	L	Н	Y7	

X: Don't care

Logic Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
DC output voltage	Vout	-0.5 to V _{CC} + 0.5	V
Input diode current	lıK	-20	mA
Output diode current	lok	±20	mA
DC output current	I _{OUT}	±25	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Operating Range (Note)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0 to 5.5	V	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	V _{OUT}	0 to V _{CC}	V	
Operating temperature	T _{opr}	−40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V _{CC} = 3.3 ± 0.3 V)	ns/V	
imput rise and rail tille	ui/uv	0 to 20 (V _{CC} = 5 ± 0.5 V)		

Note: The operating range must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			7	a = 25°0		Ta = −40 to 85°C		Unit	
Characteristics	Cymbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Onic		
High-level input voltage	V _{IH}	_			1.50 V _{CC} × 0.7	1 1	_ _	1.50 V _{CC} × 0.7	1 1	V	
Low-level input voltage	V _{IL}	_			_ _	1 1	0.50 V _{CC} × 0.3	_ _	0.50 V _{CC} × 0.3	٧	
High-level output voltage	Voн	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	_ _ _	1.9 2.9 4.4	_ _ _	V	
			$I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$	3.0 4.5	2.58 3.94	_ _	_ _	2.48 3.80	_ _		
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	Ι _{ΟL} = 50 μΑ	2.0 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V	
			$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$	3.0 4.5	_ _	_ _	0.36 0.36	_ _	0.44 0.44		
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	_	±0.1	_	±1.0	μΑ	
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5	_	_	4.0	_	40.0	μΑ	

4



AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

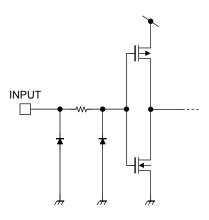
Characteristics	Symbol	Tes	st Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
	, , , ,		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
	t _{pLH}	-	3.3 ± 0.3	15	_	8.0	12.3	1.0	14.5	ns ns
Propagation delay time				50	_	10.5	15.8	1.0	18.0	
(A, B, C-Y)			5.0 ± 0.5	15	_	5.5	8.1	1.0	9.5	
				50	_	7.0	10.1	1.0	11.5	
		_	3.3 ± 0.3	15	_	8.1	12.8	1.0	15.0	
Propagation delay time	t_{pLH}			50	_	10.6	16.3	1.0	18.5	
(G1-Y)	t _{pHL}		5.0 ± 0.5	15	_	5.4	8.1	1.0	9.5	
				50	_	6.9	10.1	1.0	11.5	
		-	3.3 ± 0.3	15	_	8.1	12.3	1.0	14.5	
Propagation delay time	t _{pLH}			50	_	10.6	15.8	1.0	18.0	
(G 2 -Y)			5.0 ± 0.5	15	_	5.7	8.1	1.0	9.5	
				50	_	7.2	10.1	1.0	11.5	
Input capacitance	C _{IN}		_		_	4	_	_	10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	37	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

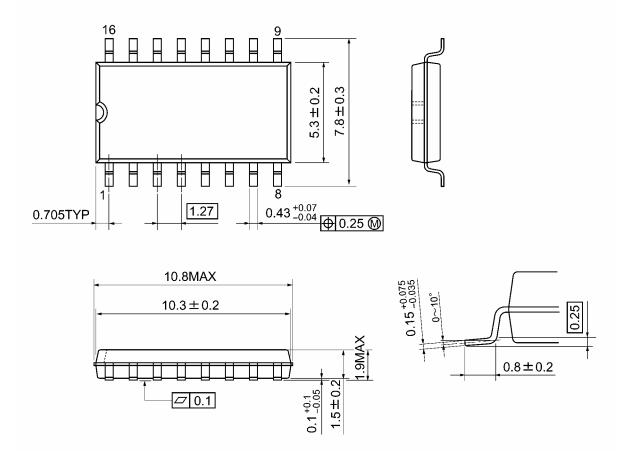
Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

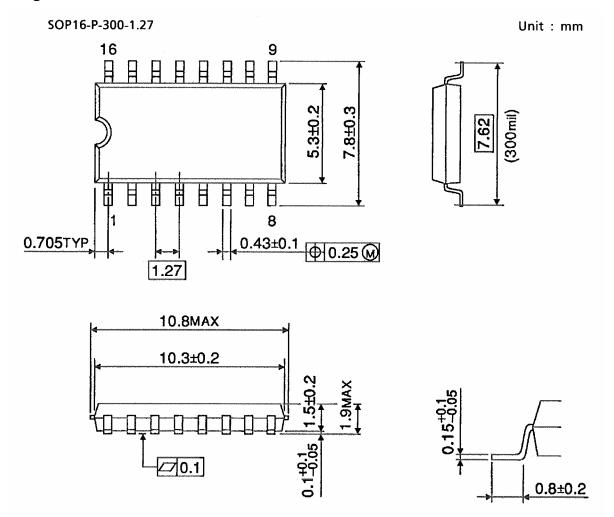
Input Equivalent Circuit



SOP16-P-300-1.27A Unit: mm



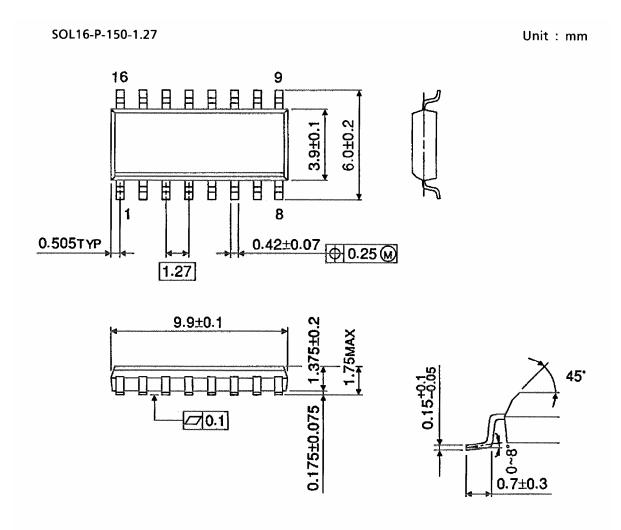
Weight: 0.18 g (typ.)



Weight: 0.18 g (typ.)



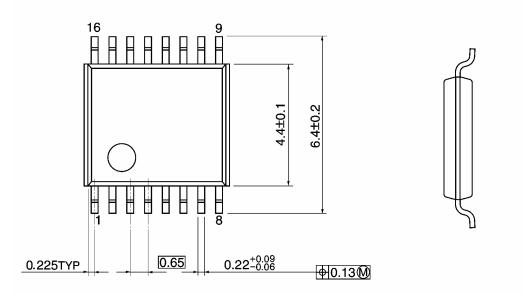
Package Dimensions (Note)

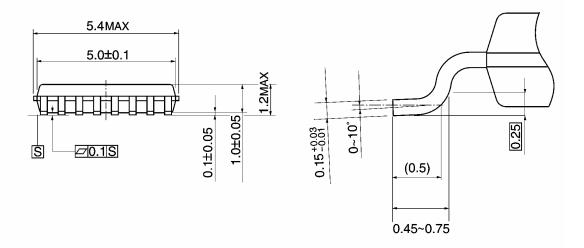


Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

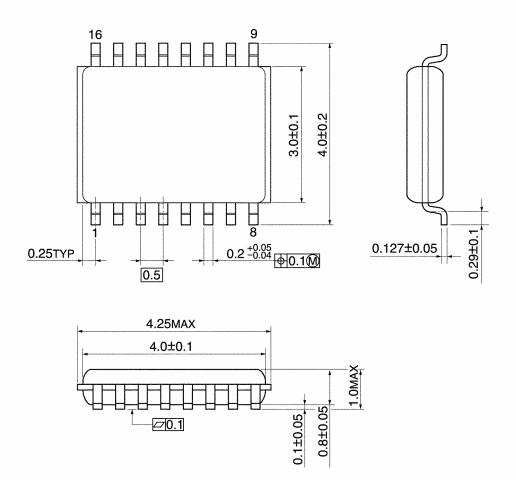
TSSOP16-P-0044-0.65A Unit: mm





Weight: 0.06 g (typ.)

VSSOP16-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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